

# 115-93-210-41-001000

#### 115-93-210-41-001000 Information

Heisener.com	 115-93-210-41-001000 Mill-Max Manufacturing Corp. Connectors, Interconnects Sockets for ICs, Transistors CONN IC DIP SOCKET 10POS GOLD - For the pricing/inventory/lead time, please contact	
For Reference Only	us Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

## **Certified Quality**

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



### 115-93-210-41-001000 Specifications

Manufacturer Part Number115-93-210-41-00100ManufacturerMill-Max Manufacturing Corp.CategoryConnectors, InterconnectsBackage-Package15Series115TypeDIP, 0.2" (5.08mm) Row SpacingNumber of Positions or Pins (Grid)10 (2 x 5)Pitch - MatingGoldContact Finish - MatingGoldContact Finish - MatingSolder CorperMounting TypeDip O.2" (5.08mm) Row SpaceFeaturesOpen FranceMounting TypeSolderFreaturesSolderFreaturesOlderPitch - PostOldor (2.54mm)Contact Finish - PostSolderContact Finish - PostSolderContact Finish - PostSolderContact Finish - PostGoldire (2.54mm)Contact Finish - PostSolderContact Finish - PostSolderContact Finish Thickness - PostSolderContact Finish - PostSolderContact Finish - PostSolderContact Finish Thickness - PostSolderContact Material - PostSolderContact			
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	Contact Finish Thickness - Post	200µin (5.08µm)	
Housing Metarial Delyayelehayylanadimethylana Taranhthalata (PCT) Delyastar	Contact Material - Post	Brass Alloy	
Housing Material Polycyclonexylenediniethylene Terephinalate (FCT), Polyester	Housing Material	Polycyclohexylenedimethylene Terephthalate (PCT), Polyester	
Operating Temperature $-55^{\circ}C \sim 125^{\circ}C$	Operating Temperature	-55°C ~ 125°C	
Report errors <sup>2</sup>			Report errors?

#### 115-93-210-41-001000 Guarantees



**Quality Guarantees** 

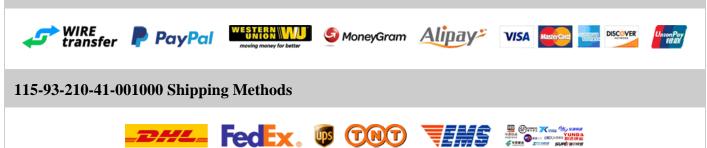
We provide 90 days warranty. \* If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

# SERVICE BUARANTEE

#### **Service Guarantees**

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

#### 115-93-210-41-001000 Payment Methods



If you have any question about 115-93-210-41-001000, please do not hesitate to contact us! Website: https://www.heisener.com

E-mail: salesdept@heisener.com